

# NCV7420

## LIN Transceiver with 3.3 V or 5 V Voltage Regulator

### General Description

The NCV7420 is a fully featured local interconnect network (LIN) transceiver designed to interface between a LIN protocol controller and the physical bus. The transceiver is implemented in I3T technology enabling both high-voltage analog circuitry and digital functionality to co-exist on the same chip.

The NCV7420 LIN device is a member of the in-vehicle networking (IVN) transceiver family of ON Semiconductor that integrates a LIN v2.0/2.1 physical transceiver and either a 3.3 V or a 5 V voltage regulator. It is designed to work in harsh automotive environment and is submitted to the TS16949 qualification flow.

The LIN bus is designed to communicate low rate data from control devices such as door locks, mirrors, car seats, and sunroofs at the lowest possible cost. The bus is designed to eliminate as much wiring as possible and is implemented using a single wire in each node. Each node has a slave MCU-state machine that recognizes and translates the instructions specific to that function. The main attraction of the LIN bus is that all the functions are not time critical and usually relate to passenger comfort.

### KEY FEATURES

#### LIN-Bus Transceiver

- LIN compliant to specification revision 2.0 and 2.1 (backward compatible to version 1.3) and J2602
- I3T high voltage technology
- Bus voltage  $\pm 45$  V
- Transmission rate up to 20 kBaud
- SOIC 14 Green package
- This is a Pb-Free Device

#### Protection

- Thermal shutdown
- Indefinite short-circuit protection on pins LIN and WAKE towards supply and ground
- Load dump protection (45 V)
- Bus pins protected against transients in an automotive environment
- System ESD protection level for LIN, WAKE and V<sub>bb</sub> up to  $\pm 12$  kV

#### EMI Compatibility

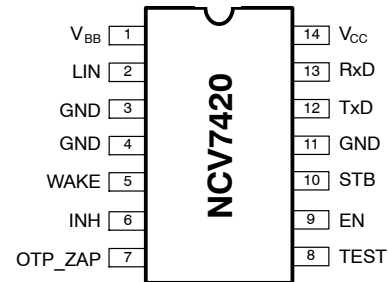
- Integrated slope control
- Meets most demanding EMS/EME requirements



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<http://onsemi.com>

### PIN CONFIGURATION



SOIC 14  
D SUFFIX  
CASE 751AP

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 14 of this data sheet.

#### Voltage Regulator

- Output voltage 5 V / ~50 mA or 3.3 V / ~50 mA
- Wake-up input
- Enable inputs for stand-by and sleep mode
- INH output for auxiliary purposes (switching of an external pull-up or resistive divider towards battery, control of an external voltage regulator etc.)

#### Modes

- Normal mode: LIN communication in either low (up to 10 kBaud) or normal slope
- Sleep mode: V<sub>CC</sub> is switched “off” and no communication on LIN bus
- Stand-by mode: V<sub>CC</sub> is switched “on” but there is no communication on LIN bus
- Wake-up bringing the component from sleep mode into standby mode is possible either by LIN command or digital input signal on WAKE pin. Wake-up from LIN bus can also be detected and flagged when the chip is already in standby mode.

#### Quality

- Automotive Qualification According to AEC-Q100, Grade 1

# NCV7420

**Table 1. KEY TECHNICAL CHARACTERISTICS – 3.3 V version**

| Symbol                          | Parameter   | Min. | Typ. | Max.            | Unit |
|---------------------------------|---|------|------|-----------------|------|
| V <sub>bb</sub>                 | Nominal battery operating voltage                                 | 5    | 12   | 26              | V    |
| V <sub>bb</sub>                 | Load dump protection (Note 1)                                     |      |      | 45              | V    |
| I <sub>bb_SLP</sub>             | Supply current in sleep mode                                      |      |      | 20              | μA   |
| V <sub>cc_out</sub><br>(Note 3) | Regulated V <sub>cc</sub> output, V <sub>cc</sub> load 1 mA–30 mA | 3.23 | 3.30 | 3.37            | V    |
|                                 | Regulated V <sub>cc</sub> output, V <sub>cc</sub> load 0 mA–50 mA | 3.19 | 3.30 | 3.41            | V    |
| I <sub>out_max</sub>            | Maximum V <sub>cc</sub> output current (Note 2)                   | 50   |      |                 | mA   |
| V <sub>wake</sub>               | Operating DC voltage on WAKE pin                                  | 0    |      | V <sub>bb</sub> | V    |
|                                 | Maximum rating voltage on WAKE pin                                | –45  |      | 45              | V    |
| T <sub>j</sub>                  | Junction thermal shutdown temperature                             | 165  |      | 195             | °C   |
| T <sub>junc</sub>               | Operating junction temperature                                    | –40  |      | +150            | °C   |

**Table 2. KEY TECHNICAL CHARACTERISTICS – 5 V version**

| Symbol                          | Parameter   | Min. | Typ. | Max.            | Unit |
|---------------------------------|---|------|------|-----------------|------|
| V <sub>bb</sub>                 | Nominal battery operating voltage                                 | 6    | 12   | 26              | V    |
| V <sub>bb</sub>                 | Load dump protection (Note 1)                                     |      |      | 45              | V    |
| I <sub>bb_SLP</sub>             | Supply current in sleep mode                                      |      |      | 20              | μA   |
| V <sub>cc_out</sub><br>(Note 3) | Regulated V <sub>cc</sub> output, V <sub>cc</sub> load 1 mA–30 mA | 4.9  | 5.0  | 5.1             | V    |
|                                 | Regulated V <sub>cc</sub> output, V <sub>cc</sub> load 0 mA–50 mA | 4.83 | 5.0  | 5.17            | V    |
| I <sub>out_max</sub>            | Maximum V <sub>cc</sub> output current (Note 2)                   | 50   |      |                 | mA   |
| V <sub>wake</sub>               | Operating DC voltage on WAKE pin                                  | 0    |      | V <sub>bb</sub> | V    |
|                                 | Maximum rating voltage on WAKE pin                                | –45  |      | 45              | V    |
| T <sub>j</sub>                  | Junction thermal shutdown temperature                             | 165  |      | 195             | °C   |
| T <sub>junc</sub>               | Operating junction temperature                                    | –40  |      | +150            | °C   |

1. The applied transients shall be in accordance with ISO 7637 part 1, test pulse 5. The device complies with functional class C; class A can be reached depending on the application and external components.
2. Thermal aspects of the entire end-application have to be taken into account in order to avoid thermal shutdown of NCV7420.
3. V<sub>cc</sub> voltage must be properly stabilized by external capacitors: capacitor of min. 80 nF with ESR<10 mΩ in parallel with a capacitor of min. 8 μF, ESR<1Ω.

**Table 3. THERMAL CHARACTERISTICS**

| Symbol                  | Parameter  | Conditions | Value | Unit |
|-------------------------|--|------------|-------|------|
| R <sub>th(vj-a)_1</sub> | Thermal resistance junction-to-ambient on JEDEC 1S0P PCB | free air   | 140   | K/W  |
| R <sub>th(vj-a)_4</sub> | Thermal resistance junction-to-ambient on JEDEC 2S2P PCB | free air   | 80    | K/W  |

# NCV7420

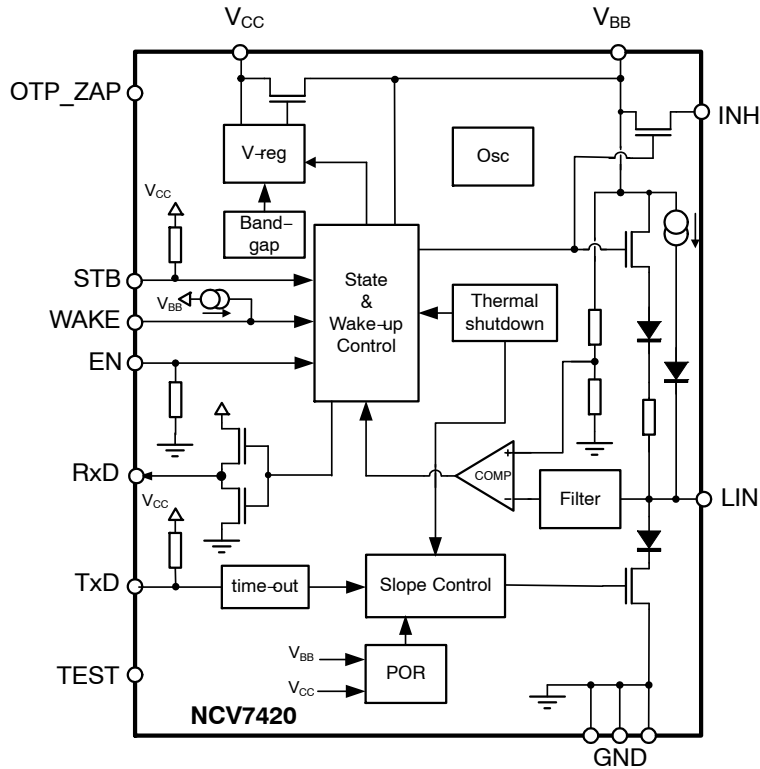


Figure 1. Block Diagram

## Typical Application

### Application Schematic

The EMC immunity of the Master-mode device can be further enhanced by adding a capacitor between the LIN output and ground. The optimum value of this capacitor is determined by the length and capacitance of the LIN bus, the

number and capacitance of Slave devices, the pull-up resistance of all devices (Master & Slave), and the required time constant of the system, respectively.

Vcc voltage must be properly stabilized by external capacitors: capacitor of min. 80 nF (ESR < 10 mΩ) in parallel with a capacitor of min. 8 μF (ESR < 1 Ω).

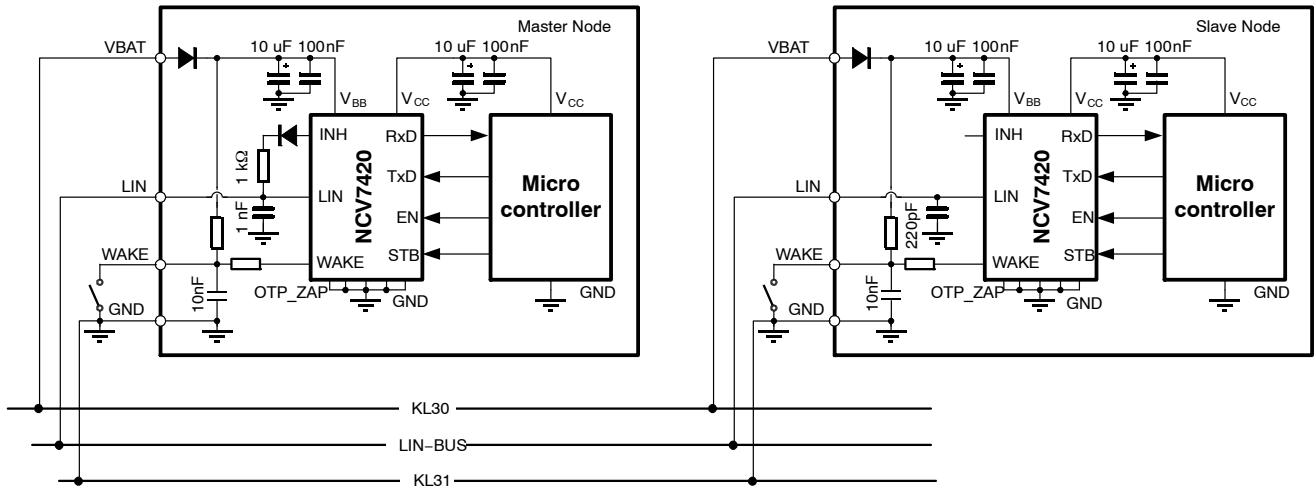


Figure 2. Typical Application Diagram

**Table 4. PIN DESCRIPTION**

| Pin | Name    | Description   |
|-----|---------|---|
| 1   | VBB     | Battery supply input  |
| 2   | LIN     | LIN bus output/input  |
| 3   | GND     | Ground  |
| 4   | GND     | Ground  |
| 5   | WAKE    | High voltage digital input pin to switch the part from sleep- to standby mode                     |
| 6   | INH     | Inhibit output  |
| 7   | OTP_ZAP | Supply for programming of trimming bits at factory testing, should be grounded in the application |
| 8   | TEST    | Digital input for factory testing, should be grounded in the application                          |
| 9   | EN      | Enable input, transceiver in normal operation mode when high                                      |
| 10  | STB     | Standby mode control input  |
| 11  | GND     | Ground  |
| 12  | TxD     | Transmit data input, low in dominant state  |
| 13  | RxD     | Receive data output; low in dominant state; push-pull output                                      |
| 14  | Vcc     | Supply voltage (output)   |

**Overall Functional Description**

LIN is a serial communication protocol that efficiently supports the control of mechatronic nodes in distributed automotive applications. The domain is class-A multiplex buses with a single master node and a set of slave nodes.

NCV7420 is designed as a master or slave node for the LIN communication interface with an integrated 3.3 V or 5 V voltage regulator having a current capability up to 50 mA for supplying any external components (microcontroller).

NCV7420 contains the LIN transmitter, LIN receiver, voltage regulator, power-on-reset (POR) circuits and thermal shutdown (TSD). The LIN transmitter is optimized for the maximum specified transmission speed of 20 kBaud

with EMC performance due to reduced slew rate of the LIN output.

The junction temperature is monitored via a thermal shutdown circuit that switches the LIN transmitter and voltage regulator off when temperature exceeds the TSD trigger level.

NCV7420 has four operating states (normal mode, low slope mode, stand-by mode, and sleep mode) that are determined by the input signals EN, WAKE, STB, and TxD.

**Operating States**

NCV7420 provides four operating states, two modes for normal operation with communication, one stand-by without communication and one low power mode with very low current consumption. See Figure 3.

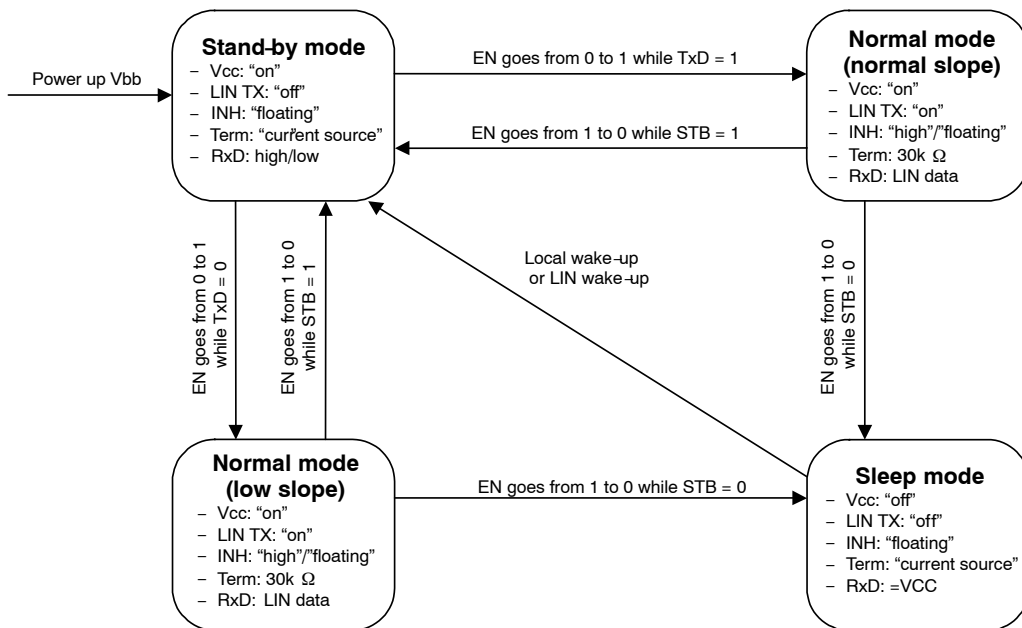


Figure 3. State Diagram

Table 5. MODE SELECTION

| Mode               | Vcc | RxD  | INH  | LIN          | 30 kΩ on LIN | Note     |
|--------------------|-----|--|--|--------------|--------------|----------|
| Normal – Slope     | ON  | Low = Dominant State<br>High = Recessive State | High if STB=High during state transition; Floating otherwise | Normal Slope | ON           | (Note 4) |
| Normal – Low Slope | ON  | Low = Dominant State<br>High = Recessive State | High if STB=High during state transition; Floating otherwise | Low Slope    | ON           | (Note 5) |
| Stand-by           | ON  | Low after LIN wakeup, high otherwise           | Floating   | OFF          | OFF          | (Note 6) |
| Sleep              | OFF | Clamped to Vcc                                 | Floating   | OFF          | OFF          |          |

- The normal slope mode is entered when pin EN goes HIGH while TxD is in HIGH state during EN transition.
- The low slope mode is entered when pin EN goes HIGH while TxD is in LOW state during EN transition. LIN transmitter gets on only after TxD returns to high after the state transition.
- The stand-by mode is entered automatically after power-up.

**Normal Slope Mode**

In normal slope mode the transceiver can transmit and receive data via LIN bus with speed up to 20 kBaud. The transmit data stream of the LIN protocol is present on the TxD pin and converted by the transmitter into a LIN bus signal with controlled slew rate to minimize EMC emission. The receiver consists of the comparator that has a threshold with hysteresis in respect to the supply voltage and an input filter to remove bus noise. The LIN output is pulled HIGH via an internal 30 kΩ pull-up resistor. For master applications it is needed to put an external 1 kΩ resistor with a serial diode between LIN and Vbb (or INH). See Figure 2. The mode selection is done by EN=HIGH when TxD pin is HIGH. If STB pin is high during the standby-to-normal slope mode transition, INH pin is pulled high. Otherwise, it stays floating.

**Low Slope Mode**

In low slope mode the slew rate of the signal on the LIN bus is reduced (rising and falling edges of the LIN bus signal

are longer). This further reduces the EMC emission. As a consequence the maximum speed on the LIN bus is reduced up to 10 kBaud. This mode is suited for applications where the communication speed is not critical. The mode selection is done by EN=HIGH when TxD pin is LOW. In order not to transmit immediately a dominant state on the bus (because TxD=LOW), the LIN transmitter is enabled only after TxD returns to HIGH. If STB pin is high during the standby-to-low slope mode transition, INH pin is pulled high. Otherwise, it stays floating.

**Stand-by Mode**

The stand-by mode is always entered after power-up of the NCV7420. It can also be entered from normal mode when the EN pin is low and the stand-by pin is high. From sleep mode it can be entered after a local wake-up or LIN wakeup. In stand-by mode the Vcc voltage regulator for supplying external components (e.g. a microcontroller) stays active. Also the LIN receiver stays active to be able to detect a remote wake-up via bus. The LIN transmitter is

disabled and the slave internal termination resistor of 30 kΩ between LIN and Vbb is disconnected in order to minimize current consumption. Only a pull-up current source between Vbb and LIN is active.

**Sleep Mode**

The Sleep Mode provides extreme low current consumption. This mode is entered when both EN and STB pins are LOW coming from normal mode. The internal termination resistor of 30 kΩ between LIN and Vbb is disconnected and also the Vcc regulator is switched off to minimize current consumption.

**Wake-up**

NCV7420 has two possibilities to wake-up from sleep or stand-by mode (see Figure 3):

- Local wake-up: enables the transition from sleep mode to stand-by mode
- Remote wake-up via LIN: enables the transition from sleep- to stand-by mode and can be also detected when already in standby mode.

A local wake-up is **only** detected in sleep mode if a transition from LOW to HIGH or from HIGH to LOW is seen on the wake pin.

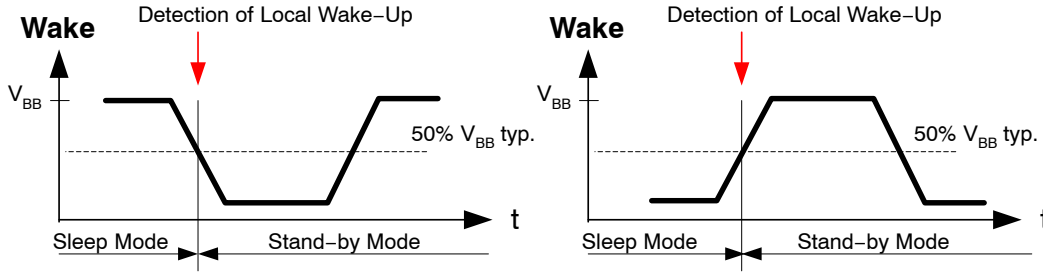


Figure 4. Local Wake-up Signal

A remote wake-up is **only** detected if a combination of (1) a falling edge at the LIN pin (transition from recessive to dominant) is followed by (2) a dominant level maintained

for a time period > t<sub>WAKE</sub> and (3) again a rising edge at pin LIN (transition from dominant to recessive) happens.

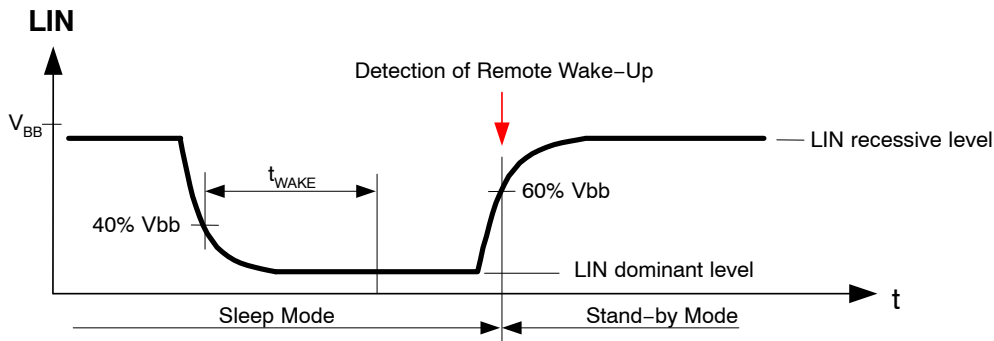


Figure 5. Remote Wake-up Behavior

The wake-up source is distinguished by pin RxD in the stand-by mode:

- RxD remains HIGH after power-up or local wake-up.

- RxD is kept LOW until normal mode is entered after a remote wake-up (LIN).

Electrical Characteristics

Definitions

All voltages are referenced to GND (Pin 13). Positive currents flow into the IC.

Table 6. ABSOLUTE MAXIMUM RATINGS – 3.3 V and 5 V versions

| Symbol                                    | Parameter   | Min. | Max.      | Unit |
|---|---|------|-----------|------|
| Vbb                                       | Battery voltage on pin Vbb (Note 7)   | -0.3 | +45       | V    |
| Vcc                                       | DC voltage on pin Vcc   | 0    | +7        | V    |
| I_Vcc                                     | Current delivered by the Vcc regulator  | 50   |           | mA   |
| V_LIN                                     | LIN bus voltage (Note 8)  | -45  | +45       | V    |
| V_INH                                     | DC voltage on inhibit pin   | -0.3 | Vbb + 0.3 | V    |
| V_WAKE                                    | DC voltage on WAKE pin  | -45  | 45        | V    |
| V_Dig_in                                  | DC input voltage on pins TxD, RxD, EN, STB  | -0.3 | Vcc + 0.3 | V    |
| Tjunc                                     | Maximum junction temperature  | -40  | +165      | °C   |
| Vesd                                      | Electrostatic discharge voltage on all pins; HBM (Note 9)                           | -2   | +2        | kV   |
|   | Electrostatic discharge voltage on LIN, INH, WAKE and Vbb towards GND; HBM (Note 9) | -4   | +4        | kV   |
|   | Electrostatic discharge on LIN, WAKE and Vbb; system HBM (Note 10)                  | -8   | +8        | kV   |
|   | Electrostatic discharge voltage on all pins; CDM (Note 12)                          | -500 | +500      | V    |
| Vesd<br>(EMC/ESD<br>improved<br>versions) | Electrostatic discharge voltage on all pins; HBM (Note 9)                           | -4   | +4        | kV   |
|   | Electrostatic discharge voltage on LIN, INH, WAKE and Vbb towards GND; HBM (Note 9) | -6   | +6        | kV   |
|   | Electrostatic discharge on LIN, WAKE and Vbb; system HBM (Note 11)                  | -12  | +12       | kV   |
|   | Electrostatic discharge voltage on all pins; CDM (Note 12)                          | -750 | +750      | V    |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

7. The applied transients shall be in accordance with ISO 7637 part 1, test pulses 1, 2, 3a, 3b, and 5. The device complies with functional class C; class A can be reached depending on the application and external components.
8. The applied transients shall be in accordance with ISO 7637 part 1, test pulses 1, 2, 3a, and 3b. The device complies with functional class C; class A can be reached depending on the application and external components.
9. Equivalent to discharging a 100 pF capacitor through a 1500 Ω resistor.
10. Equivalent to discharging a 150 pF capacitor through a 330 Ω resistor conform to IEC Standard 1000-4-2. LIN bus filter 220 pF, Vbb blocking capacitor 100 nF, 3k3/10n R/C network on WAKE.
11. Equivalent to discharging a 150 pF capacitor through a 330 Ω resistor conform to IEC Standard 1000-4-2. No filter on LIN, Vbb blocking capacitor 100 nF, 3k3/10n R/C network on WAKE.
12. Charged device model according ESD-STM5.3.1.

# NCV7420

**DC Characteristics – 3.3 V version** ( $V_{BB} = 5\text{ V to }26\text{ V}$ ;  $T_{junc} = -40^{\circ}\text{C to }+150^{\circ}\text{C}$ ; unless otherwise specified.)

**Table 7. DC CHARACTERISTICS SUPPLY – Pins VBB and VCC**

| Symbol                   | Parameter                       | Conditions   | Min. | Typ. | Max. | Unit |
|--------------------------|---------------------------------|--|------|------|------|------|
| I <sub>bb_ON</sub>       | Supply current                  | Normal mode;<br>LIN recessive  |      |      | 1    | mA   |
| I <sub>bb_STB</sub>      | Supply current                  | Stand-by mode,<br>V <sub>bb</sub> = 5–18 V,<br>T <sub>junc</sub> < 105°C |      |      | 60   | µA   |
| I <sub>bb_SLP</sub>      | Supply current                  | Sleep mode,<br>V <sub>bb</sub> = 5–18 V,<br>T <sub>junc</sub> < 105°C    |      |      | 20   | µA   |
| V <sub>cc_out</sub>      | Regulator output voltage        | V <sub>cc</sub> load 1 mA – 30 mA  | 3.23 | 3.30 | 3.37 | V    |
|                          | Regulator output voltage        | V <sub>cc</sub> load 0 mA – 50 mA  | 3.19 | 3.30 | 3.41 | V    |
| I <sub>out_max_abs</sub> | Absolute maximum output current | Thermal shutdown must<br>be taken into account                           |      |      | 50   | mA   |
| I <sub>out_lim</sub>     | Over-current limitation         |  | 50   |      | 170  | mA   |

**Table 8. DC CHARACTERISTICS LIN TRANSMITTER – Pin LIN**

| Symbol                     | Parameter                                 | Conditions  | Min.  | Typ. | Max. | Unit |
|----------------------------|---|---|---|------|------|------|
| V <sub>Lin_dom_LoSup</sub> | LIN dominant output voltage               | TXD = low;<br>V <sub>bb</sub> = 7.3 V   |   |      | 1.2  | V    |
| V <sub>Lin_dom_HiSup</sub> | LIN dominant output voltage               | TXD = low;<br>V <sub>bb</sub> = 18 V  |   |      | 2.0  | V    |
| V <sub>Lin_rec</sub>       | LIN recessive output voltage              | TXD = highH;<br>I <sub>lin</sub> = 0 mA   | V <sub>bb</sub> – V <sub>γ</sub><br>(Note 13) |      |      | V    |
| I <sub>Lin_lim</sub>       | Short circuit current limitation          | V <sub>Lin</sub> = V <sub>bb_max</sub>  | 40  |      | 200  | mA   |
| R <sub>slave</sub>         | Internal pull-up resistance               |   | 20  | 33   | 47   | kΩ   |
| I <sub>Lin_off_dom</sub>   | LIN output current bus in dominant state  | Driver off; V <sub>bb</sub> = 12 V  | –1  |      |      | mA   |
| I <sub>Lin_off_rec</sub>   | LIN output current bus in recessive state | Driver off; V <sub>bb</sub> < 18 V<br>V <sub>bb</sub> < V <sub>Lin</sub> < 18 V |   |      | 1    | µA   |
| I <sub>Lin_no_GND</sub>    | Communication not affected                | V <sub>bb</sub> = GND = 12 V;<br>0 < V <sub>Lin</sub> < 18 V                    | –1  |      | 1    | mA   |
| I <sub>Lin_no_Vbb</sub>    | LIN bus remains operational               | V <sub>bb</sub> = GND = 0 V;<br>0 < V <sub>Lin</sub> < 18 V                     |   |      | 5    | µA   |

**Table 9. DC CHARACTERISTICS LIN RECEIVER – Pin LIN**

| Symbol               | Parameter                       | Conditions  | Min.  | Typ. | Max.  | Unit            |
|----------------------|---------------------------------|---|-------|------|-------|-----------------|
| V <sub>bus_dom</sub> | Bus voltage for dominant state  |   |       |      | 0.4   | V <sub>bb</sub> |
| V <sub>bus_rec</sub> | Bus voltage for recessive state |   | 0.6   |      |       | V <sub>bb</sub> |
| V <sub>rec_dom</sub> | Receiver threshold              | LIN bus recessive →<br>dominant                       | 0.4   |      | 0.6   | V <sub>bb</sub> |
| V <sub>rec_rec</sub> | Receiver threshold              | LIN bus dominant →<br>recessive                       | 0.4   |      | 0.6   | V <sub>bb</sub> |
| V <sub>rec_cnt</sub> | Receiver centre voltage         | (V <sub>bus_dom</sub> + V <sub>bus_rec</sub> )<br>/ 2 | 0.475 |      | 0.525 | V <sub>bb</sub> |
| V <sub>rec_hys</sub> | Receiver hysteresis             |   | 0.05  |      | 0.175 | V <sub>bb</sub> |

13. V<sub>γ</sub> is the forward diode voltage. Typically (over the complete temperature) V<sub>γ</sub> = 1 V.

14. By one of the trimming bits, following reconfiguration can be done during chip-level testing in order to fit the NCV7420\_3 into different interface: pins TxD and EN will have typ. 10 kΩ pull-down resistor to ground and pin WAKE will have typ. 10 µA pull-up current source.



# NCV7420

**DC Characteristics – 3.3 V version** ( $V_{BB} = 5\text{ V to }26\text{ V}$ ;  $T_{junc} = -40^{\circ}\text{C to }+150^{\circ}\text{C}$ ; unless otherwise specified.)

**Table 10. DC CHARACTERISTICS I/Os**

| Symbol                  | Parameter                                       | Conditions   | Min.                        | Typ. | Max. | Unit            |
|-------------------------|---|--|-----------------------------|------|------|-----------------|
| <b>Pin WAKE</b>         |   |  |                             |      |      |                 |
| V_wake_th               | Threshold voltage                               |  | 0.35                        |      | 0.65 | V <sub>bb</sub> |
| I_leak                  | Input leakage current (Note 14)                 | V <sub>wake</sub> = 0 V;<br>V <sub>bb</sub> = 18 V | -1                          | -0.5 | 1    | μA              |
| T_wake_min              | Debounce time                                   | Sleep mode; rising<br>and falling edge             | 8                           |      | 54   | μs              |
| <b>Pins TxD and STB</b> |   |  |                             |      |      |                 |
| V <sub>il</sub>         | Low level input voltage                         |  |                             |      | 0.8  | V               |
| V <sub>ih</sub>         | High level input voltage                        |  | 2.0                         |      |      | V               |
| R <sub>pu</sub>         | Pull-up resistance to V <sub>cc</sub> (Note 14) |  | 50                          |      | 200  | kΩ              |
| <b>Pin INH</b>          |   |  |                             |      |      |                 |
| Delta_VH                | High level voltage drop                         | I <sub>INH</sub> = 15 mA                           |                             | 0.35 | 0.75 | V               |
| I_leak                  | Leakage current                                 | Sleep mode; V <sub>INH</sub> = 0 V                 | -1                          |      | 1    | μA              |
| <b>Pin EN</b>           |   |  |                             |      |      |                 |
| V <sub>il</sub>         | Low level input voltage                         |  |                             |      | 0.8  | V               |
| V <sub>ih</sub>         | High level input voltage                        |  | 2.0                         |      |      | V               |
| R <sub>pd</sub>         | Pull-down resistance to ground (Note 14)        |  | 50                          |      | 200  | kΩ              |
| <b>Pin RxD</b>          |   |  |                             |      |      |                 |
| V <sub>ol</sub>         | Low level output voltage                        | I <sub>sink</sub> = 2 mA                           |                             |      | 0.65 | V               |
| V <sub>oh</sub>         | High level output voltage                       | I <sub>source</sub> = -2 mA                        | V <sub>cc</sub> -<br>0.65 V |      |      | V               |

**Table 11. DC CHARACTERISTICS**

| Symbol              | Parameter   | Conditions   | Min. | Typ. | Max. | Unit |
|---------------------|---|--------------|------|------|------|------|
| <b>POR</b>          |   |              |      |      |      |      |
| PORH_Vbb            | POR high level V <sub>bb</sub> comparator         |              |      |      | 4.5  | V    |
| PORL_Vbb            | POR low level V <sub>bb</sub> comparator          |              | 1.7  |      |      | V    |
| POR_Vbb_sl          | Maximum slope on V <sub>bb</sub> to guarantee POR |              |      |      | 50   | V/ms |
| PORH_Vcc            | POR high level V <sub>cc</sub> comparator         |              |      |      | 3    | V    |
| PORL_Vcc            | POR low level V <sub>cc</sub> comparator          |              | 2    |      |      | V    |
| <b>TSD</b>          |   |              |      |      |      |      |
| T <sub>j</sub>      | Junction temperature                              | For shutdown | 165  |      | 195  | °C   |
| T <sub>j_hyst</sub> | Thermal shutdown hysteresis                       |              | 9    |      | 18   | °C   |

13. V<sub>γ</sub> is the forward diode voltage. Typically (over the complete temperature) V<sub>γ</sub> = 1 V.

14. By one of the trimming bits, following reconfiguration can be done during chip-level testing in order to fit the NCV7420\_3 into different interface: pins TxD and EN will have typ. 10 kΩ pull-down resistor to ground and pin WAKE will have typ. 10 μA pull-up current source.

# NCV7420

**DC Characteristics – 5 V version** – ( $V_{BB} = 6\text{ V to }26\text{ V}$ ;  $T_{junc} = -40^{\circ}\text{C to }+150^{\circ}\text{C}$ ; unless otherwise specified.)

**Table 12. DC CHARACTERISTICS SUPPLY – Pins VBB and VCC**

| Symbol                   | Parameter                       | Conditions   | Min. | Typ. | Max. | Unit |
|--------------------------|---------------------------------|--|------|------|------|------|
| I <sub>bb_ON</sub>       | Supply current                  | Normal mode;<br>LIN recessive  |      |      | 1    | mA   |
| I <sub>bb_STB</sub>      | Supply current                  | Stand-by mode,<br>V <sub>bb</sub> = 6–18 V,<br>T <sub>junc</sub> < 105°C |      |      | 60   | μA   |
| I <sub>bb_SLP</sub>      | Supply current                  | Sleep mode,<br>V <sub>bb</sub> = 6–18 V,<br>T <sub>junc</sub> < 105°C    |      |      | 20   | μA   |
| V <sub>cc_out</sub>      | Regulator output voltage        | V <sub>cc</sub> load 1 mA – 30 mA  | 4.9  | 5.0  | 5.1  | V    |
|                          | Regulator output voltage        | V <sub>cc</sub> load 0 mA – 50 mA  | 4.83 | 5.0  | 5.17 | V    |
| I <sub>out_max_abs</sub> | Absolute maximum output current | Thermal shutdown must<br>be taken into account                           |      |      | 50   | mA   |
| I <sub>out_lim</sub>     | Over-current limitation         |  | 50   |      | 170  | mA   |

**Table 13. DC CHARACTERISTICS LIN TRANSMITTER – Pin LIN**

| Symbol                     | Parameter                                 | Conditions  | Min.  | Typ. | Max. | Unit |
|----------------------------|---|---|---|------|------|------|
| V <sub>Lin_dom_LoSup</sub> | LIN dominant output voltage               | TXD = low; V <sub>bb</sub> = 7.3 V  |   |      | 1.2  | V    |
| V <sub>Lin_dom_HiSup</sub> | LIN dominant output voltage               | TXD = low; V <sub>bb</sub> = 18 V   |   |      | 2.0  | V    |
| V <sub>Lin_rec</sub>       | LIN recessive output voltage              | TXD = highH;<br>I <sub>lin</sub> = 0 mA   | V <sub>bb</sub> – V <sub>γ</sub><br>(Note 15) |      |      | V    |
| I <sub>LIN_lim</sub>       | Short circuit current limitation          | V <sub>Lin</sub> = V <sub>bb_max</sub>  | 40  |      | 200  | mA   |
| R <sub>slave</sub>         | Internal pull-up resistance               |   | 20  | 33   | 47   | kΩ   |
| I <sub>LIN_off_dom</sub>   | LIN output current bus in dominant state  | Driver off; V <sub>bb</sub> = 12 V  | –1  |      |      | mA   |
| I <sub>LIN_off_rec</sub>   | LIN output current bus in recessive state | Driver off; V <sub>bb</sub> < 18 V<br>V <sub>bb</sub> < V <sub>Lin</sub> < 18 V |   |      | 1    | μA   |
| I <sub>LIN_no_GND</sub>    | Communication not affected                | V <sub>bb</sub> = GND = 12 V;<br>0 < V <sub>Lin</sub> < 18 V                    | –1  |      | 1    | mA   |
| I <sub>LIN_no_Vbb</sub>    | LIN bus remains operational               | V <sub>bb</sub> = GND = 0 V;<br>0 < V <sub>Lin</sub> < 18 V                     |   |      | 5    | μA   |

**Table 14. DC CHARACTERISTICS LIN RECEIVER – Pin LIN**

| Symbol               | Parameter                       | Conditions  | Min.  | Typ. | Max.  | Unit            |
|----------------------|---------------------------------|---|-------|------|-------|-----------------|
| V <sub>bus_dom</sub> | Bus voltage for dominant state  |   |       |      | 0.4   | V <sub>bb</sub> |
| V <sub>bus_rec</sub> | Bus voltage for recessive state |   | 0.6   |      |       | V <sub>bb</sub> |
| V <sub>rec_dom</sub> | Receiver threshold              | LIN bus recessive →<br>dominant                       | 0.4   |      | 0.6   | V <sub>bb</sub> |
| V <sub>rec_rec</sub> | Receiver threshold              | LIN bus dominant →<br>recessive                       | 0.4   |      | 0.6   | V <sub>bb</sub> |
| V <sub>rec_cnt</sub> | Receiver center voltage         | (V <sub>bus_dom</sub> + V <sub>bus_rec</sub> )<br>/ 2 | 0.475 |      | 0.525 | V <sub>bb</sub> |
| V <sub>rec_hys</sub> | Receiver hysteresis             |   | 0.05  |      | 0.175 | V <sub>bb</sub> |

15. V<sub>γ</sub> is the forward diode voltage. Typically (over the complete temperature) V<sub>γ</sub> = 1 V.

16. By one of the trimming bits, following reconfiguration can be done during chip-level testing in order to fit the NCV7420\_5 into different interface: pins TxD and EN will have typ. 10 kΩ pull-down resistor to ground and pin WAKE will have typ. 10 μA pull-up current source.

# NCV7420

**DC Characteristics – 5 V version** – ( $V_{BB} = 6\text{ V to }26\text{ V}$ ;  $T_{junc} = -40^{\circ}\text{C to }+150^{\circ}\text{C}$ ; unless otherwise specified.)

**Table 15. DC CHARACTERISTICS I/OS**

| Symbol                  | Parameter                                       | Conditions   | Min.                     | Typ. | Max. | Unit            |
|-------------------------|---|--|--------------------------|------|------|-----------------|
| <b>Pin WAKE</b>         |   |  |                          |      |      |                 |
| V_wake_th               | Threshold voltage                               |  | 0.35                     |      | 0.65 | V <sub>bb</sub> |
| I_leak                  | Input leakage current (Note 16)                 | V <sub>wake</sub> = 0 V;<br>V <sub>bb</sub> = 18 V | -1                       | -0.5 | 1    | μA              |
| T_wake_min              | Debounce time                                   | Sleep mode; rising and falling edge                | 8                        |      | 54   | μs              |
| <b>Pins TxD and STB</b> |   |  |                          |      |      |                 |
| V <sub>il</sub>         | Low level input voltage                         |  |                          |      | 0.8  | V               |
| V <sub>ih</sub>         | High level input voltage                        |  | 2.0                      |      |      | V               |
| R <sub>pu</sub>         | Pull-up resistance to V <sub>cc</sub> (Note 16) |  | 50                       |      | 200  | kΩ              |
| <b>Pin INH</b>          |   |  |                          |      |      |                 |
| Delta_VH                | High level voltage drop                         | I <sub>INH</sub> = 15 mA                           |                          | 0.35 | 0.75 | V               |
| I_leak                  | Leakage current                                 | Sleep mode; V <sub>INH</sub> = 0 V                 | -1                       |      | 1    | μA              |
| <b>Pin EN</b>           |   |  |                          |      |      |                 |
| V <sub>il</sub>         | Low level input voltage                         |  |                          |      | 0.8  | V               |
| V <sub>ih</sub>         | High level input voltage                        |  | 2.0                      |      |      | V               |
| R <sub>pd</sub>         | Pull-down resistance to ground (Note 16)        |  | 50                       |      | 200  | kΩ              |
| <b>Pin RxD</b>          |   |  |                          |      |      |                 |
| V <sub>ol</sub>         | Low level output voltage                        | I <sub>sink</sub> = 2 mA                           |                          |      | 0.65 | V               |
| V <sub>oh</sub>         | High level output voltage                       | I <sub>source</sub> = -2 mA                        | V <sub>cc</sub> - 0.65 V |      |      | V               |

**Table 16. DC CHARACTERISTICS**

| Symbol              | Parameter   | Conditions   | Min. | Typ. | Max. | Unit |
|---------------------|---|--------------|------|------|------|------|
| <b>POR</b>          |   |              |      |      |      |      |
| PORH_Vbb            | POR high level V <sub>bb</sub> comparator         |              |      |      | 4.5  | V    |
| PORL_Vbb            | POR low level V <sub>bb</sub> comparator          |              | 1.7  |      |      | V    |
| POR_Vbb_sl          | Maximum slope on V <sub>bb</sub> to guarantee POR |              |      |      | 50   | V/ms |
| PORH_Vcc            | POR high level V <sub>cc</sub> comparator         |              |      |      | 4.5  | V    |
| PORL_Vcc            | POR low level V <sub>cc</sub> comparator          |              | 3    |      |      | V    |
| <b>TSD</b>          |   |              |      |      |      |      |
| T <sub>j</sub>      | Junction temperature                              | For shutdown | 165  |      | 195  | °C   |
| T <sub>j_hyst</sub> | Thermal shutdown hysteresis                       |              | 9    |      | 18   | °C   |

15. V<sub>γ</sub> is the forward diode voltage. Typically (over the complete temperature) V<sub>γ</sub> = 1 V.

16. By one of the trimming bits, following reconfiguration can be done during chip-level testing in order to fit the NCV7420\_5 into different interface: pins TxD and EN will have typ. 10 kΩ pull-down resistor to ground and pin WAKE will have typ. 10 μA pull-up current source.

# NCV7420

**AC Characteristics – 3.3 V and 5 V versions** – ( $V_{BB} = 7\text{ V to }18\text{ V}$ ;  $T_{junc} = -40^{\circ}\text{C to }+150^{\circ}\text{C}$ ; unless otherwise specified.)

**Table 17. AC CHARACTERISTICS LIN TRANSMITTER – Pin LIN**

| Symbol      | Parameter   | Conditions   | Min.  | Typ. | Max.  | Unit          |
|-------------|---|--|-------|------|-------|---------------|
| D1          | Duty Cycle 1 = $t_{BUS\_REC(min)} / (2 \times T_{Bit})$ | $TH_{REC(max)} = 0.744 \times V_{BB}$<br>$TH_{DOM(max)} = 0.581 \times V_{BB}$<br>$T_{BIT} = 50\ \mu\text{s}$<br>$V(V_{BB}) = 7\text{ V to }18\text{ V}$   | 0.396 |      | 0.5   |               |
| D2          | Duty Cycle 2 = $t_{BUS\_REC(max)} / (2 \times T_{Bit})$ | $TH_{REC(min)} = 0.422 \times V_{BB}$<br>$TH_{DOM(min)} = 0.284 \times V_{BB}$<br>$T_{BIT} = 50\ \mu\text{s}$<br>$V(V_{BB}) = 7.6\text{ V to }18\text{ V}$ | 0.5   |      | 0.581 |               |
| D3          | Duty Cycle 3 = $t_{BUS\_REC(min)} / (2 \times T_{Bit})$ | $TH_{REC(max)} = 0.778 \times V_{BB}$<br>$TH_{DOM(max)} = 0.616 \times V_{BB}$<br>$T_{BIT} = 96\ \mu\text{s}$<br>$V(V_{BB}) = 7\text{ V to }18\text{ V}$   | 0.417 |      | 0.5   |               |
| D4          | Duty Cycle 4 = $t_{BUS\_REC(max)} / (2 \times T_{Bit})$ | $TH_{REC(min)} = 0.389 \times V_{BB}$<br>$TH_{DOM(min)} = 0.251 \times V_{BB}$<br>$T_{BIT} = 96\ \mu\text{s}$<br>$V(V_{BB}) = 7.6\text{ V to }18\text{ V}$ | 0.5   |      | 0.590 |               |
| T_fall_norm | LIN falling edge  | Normal slope mode;<br>$V_{BB} = 12\text{ V}$ ; L1, L2<br>(Note 17)   |       |      | 22.5  | $\mu\text{s}$ |
| T_rise_norm | LIN rising edge   | Normal slope mode;<br>$V_{BB} = 12\text{ V}$ ; L1, L2<br>(Note 17)   |       |      | 22.5  | $\mu\text{s}$ |
| T_sym_norm  | LIN slope symmetry                                      | Normal slope mode;<br>$V_{BB} = 12\text{ V}$ ; L1, L2<br>(Note 17)   | -4    |      | 4     | $\mu\text{s}$ |
| T_fall_norm | LIN falling edge  | Normal slope mode;<br>$V_{BB} = 12\text{ V}$ ; L3 (Note 17)  |       |      | 27    | $\mu\text{s}$ |
| T_rise_norm | LIN rising edge   | Normal slope mode;<br>$V_{BB} = 12\text{ V}$ ; L3 (Note 17)  |       |      | 27    | $\mu\text{s}$ |
| T_sym_norm  | LIN slope symmetry                                      | Normal slope mode;<br>$V_{BB} = 12\text{ V}$ ; L3 (Note 17)  | -5    |      | 5     | $\mu\text{s}$ |
| T_fall_low  | LIN falling edge  | Low slope mode (Note 18);<br>$V_{BB} = 12\text{ V}$ ; L3 (Note 17)   |       |      | 62    | $\mu\text{s}$ |
| T_rise_low  | LIN rising edge   | Low slope mode (Note 18);<br>$V_{BB} = 12\text{ V}$ ; L3 (Note 17)   |       |      | 62    | $\mu\text{s}$ |
| T_wake      | Dominant time-out for wake-up via LIN bus               |  | 30    |      | 150   | $\mu\text{s}$ |
| T_dom       | TxD dominant time-out                                   | TxD = low  | 6     |      | 20    | ms            |

17. The AC parameters are specified for following RC loads on the LIN bus: L1 = 1 k $\Omega$  / 1 nF; L2 = 660  $\Omega$  / 6.8 nF; L3 = 500  $\Omega$  / 10 nF.

18. Low slope mode is not compliant to the LIN standard.

# NCV7420

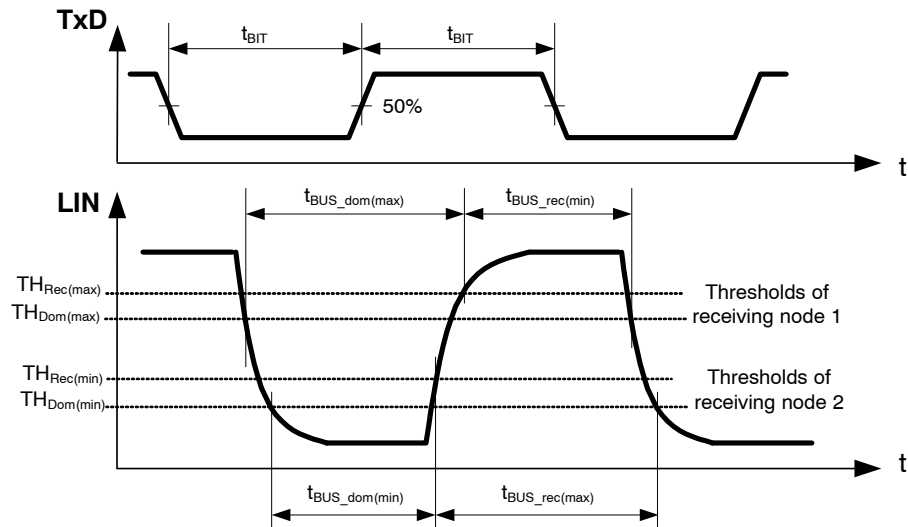


Figure 6. LIN Transmitter Duty Cycle

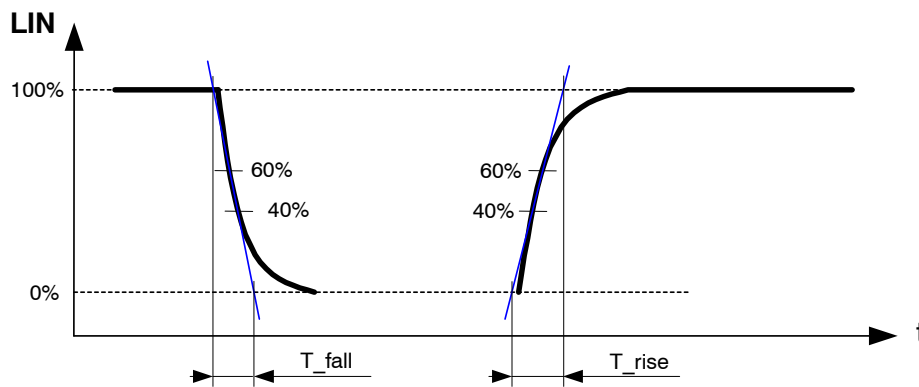


Figure 7. LIN Transmitter Rising and Falling Times

Table 18. AC CHARACTERISTICS LIN RECEIVER

| Symbol<br>Pin LIN | Parameter                                  | Conditions                       | Min. | Typ. | Max. | Unit    |
|-------------------|--|----------------------------------|------|------|------|---------|
| Trec_prop_down    | Propagation delay of receiver falling edge |                                  | 0.1  |      | 6    | $\mu$ s |
| Trec_prop_up      | Propagation delay of receiver rising edge  |                                  | 0.1  |      | 6    | $\mu$ s |
| Trec_sym          | Propagation delay symmetry                 | Trec_prop_down –<br>Trec_prop_up | -2   |      | 2    | $\mu$ s |

# NCV7420

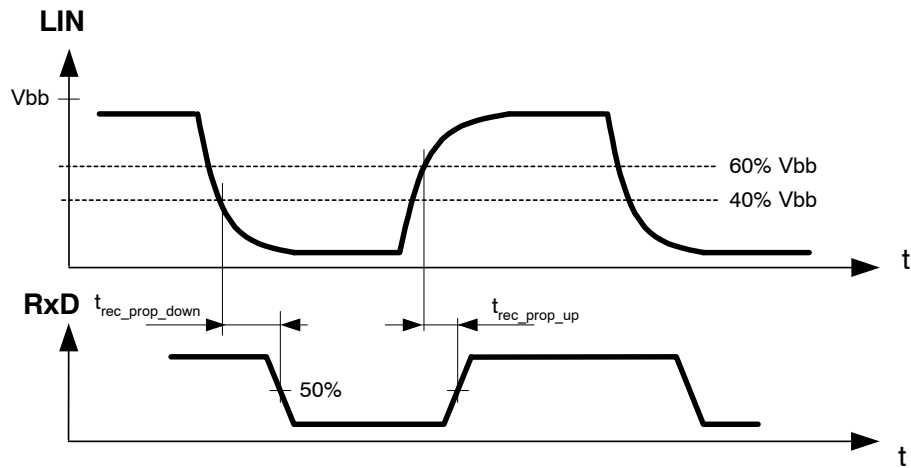


Figure 8. LIN Receiver Timing

## ORDERING INFORMATION

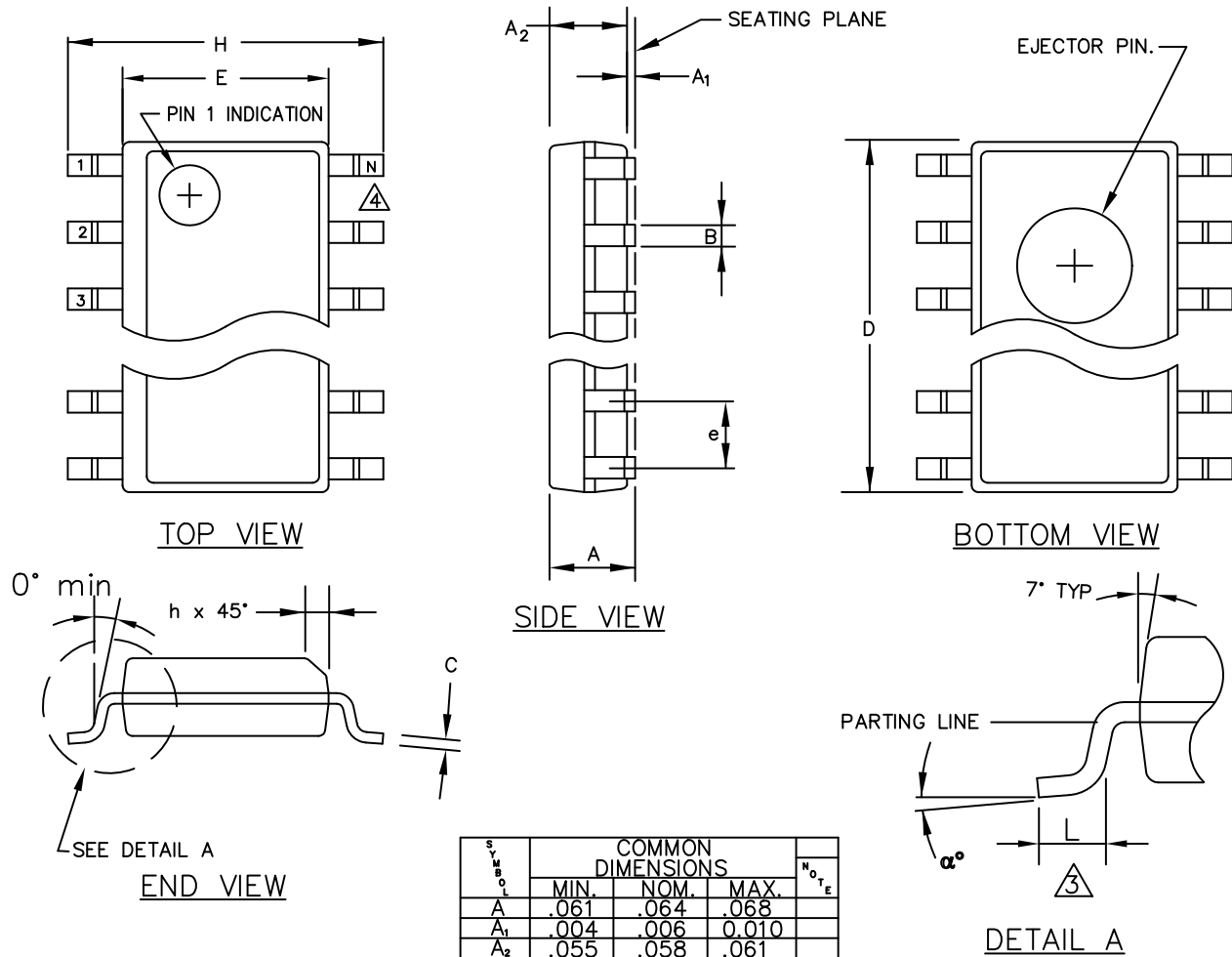
| Part Number   | Description                                    | Package                          | Container             |      | Temperature Range |
|---------------|--|----------------------------------|-----------------------|------|-------------------|
|               |  |                                  | Shipping <sup>†</sup> | Qty. |                   |
| NCV7420D23G   | LIN Transceiver + 3.3 V Vreg.                  | SOIC 150 14 GREEN (JEDEC MS-012) | Tube/Rail             | 55   | -40°C to 125°C    |
| NCV7420D23R2G | LIN Transceiver + 3.3 V Vreg.                  | SOIC 150 14 GREEN (JEDEC MS-012) | Tape & Reel           | 3000 | -40°C to 125°C    |
| NCV7420D24G   | EMC/ESD Improved LIN Transceiver + 3.3 V Vreg. | SOIC 150 14 GREEN (JEDEC MS-012) | Tube/Rail             | 55   | -40°C to 125°C    |
| NCV7420D24R2G | EMC/ESD Improved LIN Transceiver + 3.3 V Vreg. | SOIC 150 14 GREEN (JEDEC MS-012) | Tape & Reel           | 3000 | -40°C to 125°C    |
| NCV7420D25G   | LIN Transceiver + 5 V Vreg.                    | SOIC 150 14 GREEN (JEDEC MS-012) | Tube/Rail             | 55   | -40°C to 125°C    |
| NCV7420D25R2G | LIN Transceiver + 5 V Vreg.                    | SOIC 150 14 GREEN (JEDEC MS-012) | Tape & Reel           | 3000 | -40°C to 125°C    |
| NCV7420D26G   | EMC/ESD Improved LIN Transceiver + 5 V Vreg.   | SOIC 150 14 GREEN (JEDEC MS-012) | Tube/Rail             | 55   | -40°C to 125°C    |
| NCV7420D26R2G | EMC/ESD Improved LIN Transceiver + 5 V Vreg.   | SOIC 150 14 GREEN (JEDEC MS-012) | Tape & Reel           | 3000 | -40°C to 125°C    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# NCV7420


## PACKAGE DIMENSIONS

SOIC 14  
CASE 751AP-01  
ISSUE A



| SYMBOL         | COMMON DIMENSIONS |      |       | NOTE |
|----------------|-------------------|------|-------|------|
|                | MIN.              | NOM. | MAX.  |      |
| A              | .061              | .064 | .068  |      |
| A <sub>1</sub> | .004              | .006 | 0.010 |      |
| A <sub>2</sub> | .055              | .058 | .061  |      |
| B              | .0138             | .016 | .020  |      |
| C              | .0075             | .008 | .0098 |      |
| D              | SEE VARIATIONS    |      |       | 1    |
| E              | .150              | .155 | .157  |      |
| e              | .050 BSC          |      |       |      |
| H              | .230              | .236 | .244  |      |
| h              | .010              | .013 | .016  |      |
| L              | .016              | .025 | .035  |      |
| N              | SEE VARIATIONS    |      |       | 2    |
| $\alpha^\circ$ | 0°                | 5°   | 8°    |      |

| VARIATIONS |      |      |      |    |
|------------|------|------|------|----|
|            | 1    |      |      | 2  |
|            | D    |      |      | N  |
| NOTE       | MIN. | NOM. | MAX. |    |
| AA         | .189 | .194 | .196 | 8  |
| AB         | .337 | .342 | .344 | 14 |
| AC         | .386 | .391 | .393 | 16 |

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